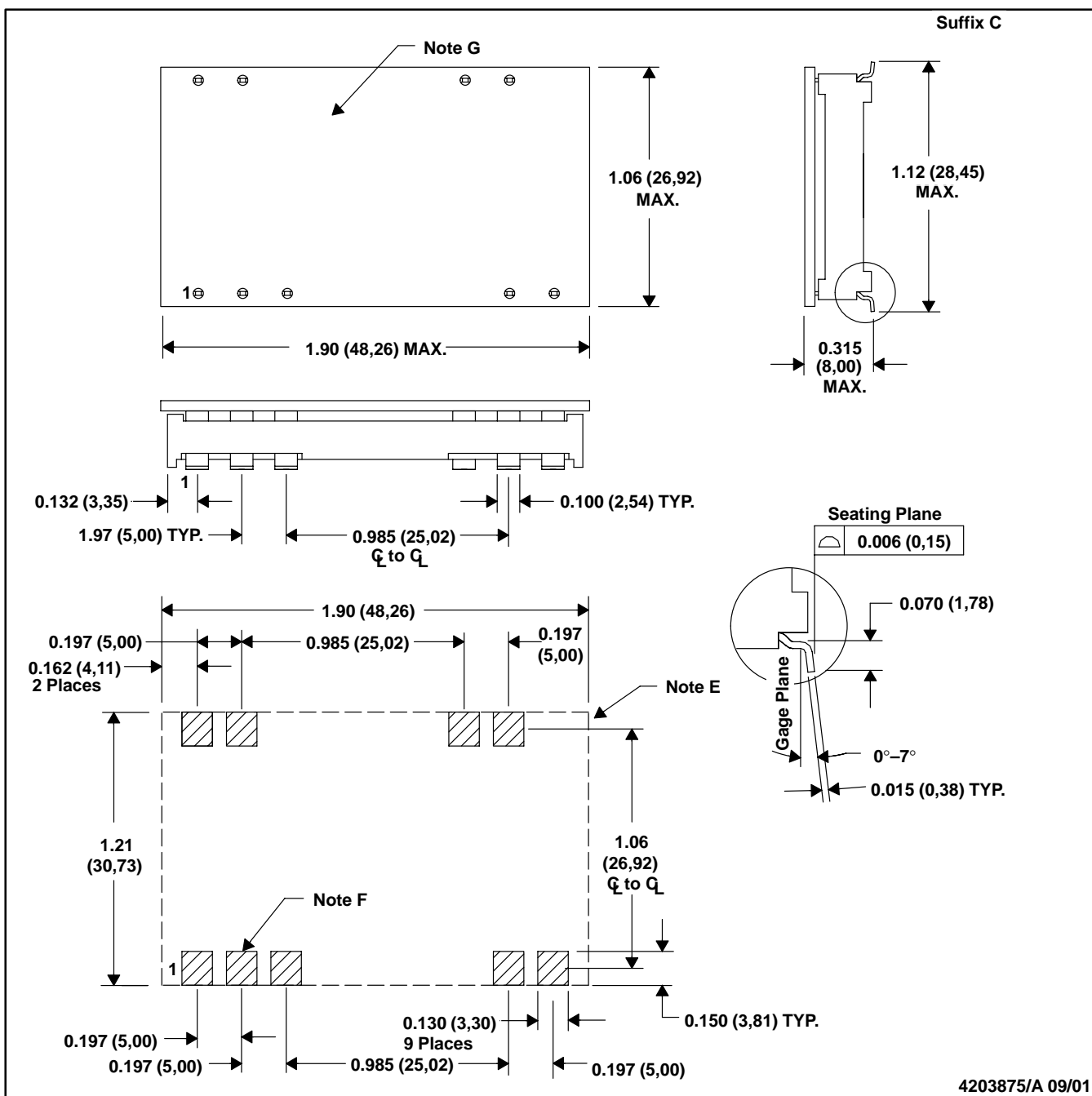


## EGL (R-PDIP-G9)

## PLASTIC DUAL-IN-LINE MODULE



- NOTES: A. All linear dimensions are in inches (mm).  
 B. This drawing is subject to change without notice.  
 C. 2 place decimals are  $\pm 0.030$  ( $\pm 0,76$ mm).  
 D. 3 place decimals are  $\pm 0.010$  ( $\pm 0,25$ mm).  
 E. Recommended mechanical keep out area.  
 F. Power pin connection should utilize two or more vias per input, ground and output pin.  
 G. Keepout area, printed circuit board exposed (Top View).

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